In the Claims

Please amend the claims as follows.

(Currently Amended) A method for wiring connection, comprising steps of:
applying at least a barrel pin to a printed circuit board;
riveting one end of said barrel pin to said printed circuit board;
soldering said barrel pin on said printed circuit board;

inserting at least a wiring into said barrel pin <u>having been soldered on said</u>

<u>printed circuit board</u> via the other end of said barrel pin; and

fixing said wiring inside said barrel pin.

- 2. (Original) The method according to claim 1, wherein said barrel pin and said printed circuit board are electrically soldered together through passing through an air reflow oven.
- 3. (Original) The method according to claim 1 further comprising a step of: mounting at least an electronic element on said printed circuit board so as to be passed through an air reflow oven simultaneously with said printed circuit board and said barrel pin.
- 4. (Original) The method according to claim 1, wherein said wiring connection is a process for an electronic ballast.

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5. (Original) The method according to claim 1, wherein said barrel pin is tin-

plated so that a wetting ability thereof becomes relatively worse.

6. (Original) The method according to claim 1, wherein said riveting step is

performed by a first tool.

7. (Original) The method according to claim 1, wherein said fixing step is

performed by a second tool.

8. (Original) The method according to claim 7, wherein said second tool is a

taper tool for hitting said barrel pin to form a taper recess so as to fasten said

wiring thereinside.

9. (Currently Amended) A wiring connection device for a printed circuit

board, comprising: at least a barrel pin mounted having one end directly riveted and

soldered at said printed circuit board being riveted and soldered thereon for an

electrical connection between said printed circuit board and said barrel pin; and hit

for fastening at least a wiring thereinside and inserted in said barrel pin for an

electrical connection between said barrel pin and said wiring.

10. (Original) The device according to claim 9, wherein said barrel pin is

riveted by a first tool.

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11. (Original) The device according to claim 9, wherein said barrel pin is fitted

by a second tool.

12.(Original) The device according to claim 11, wherein said second tool is a

taper tool for fitting said barrel pin into a taper recess so as to fasten said wiring

thereinside.

13.(Original) The device according to claim 9, wherein said barrel pin and

said printed circuit board are electrically soldered together through passing through

an air reflow oven.

14. (Original) The device according to claim 9, wherein said wiring connection

device is used for an electronic ballast.

15.(Currently Amended) A wiring connection device for a printed circuit

board, comprising: at least two barrel pins mounted at a side of said printed circuit

board, and being directly riveted and soldered thereon for an electrical connection

between said barrel pins and said printed circuit board; and hit for fastening at

least a wiring fastened in said barrel pins thereinside and for an electrical

connection between said barrel pins and said wiring.

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